# Numerical study of heat and mass transfer during contact heating of potato slices

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#### **INRODUCTION**:

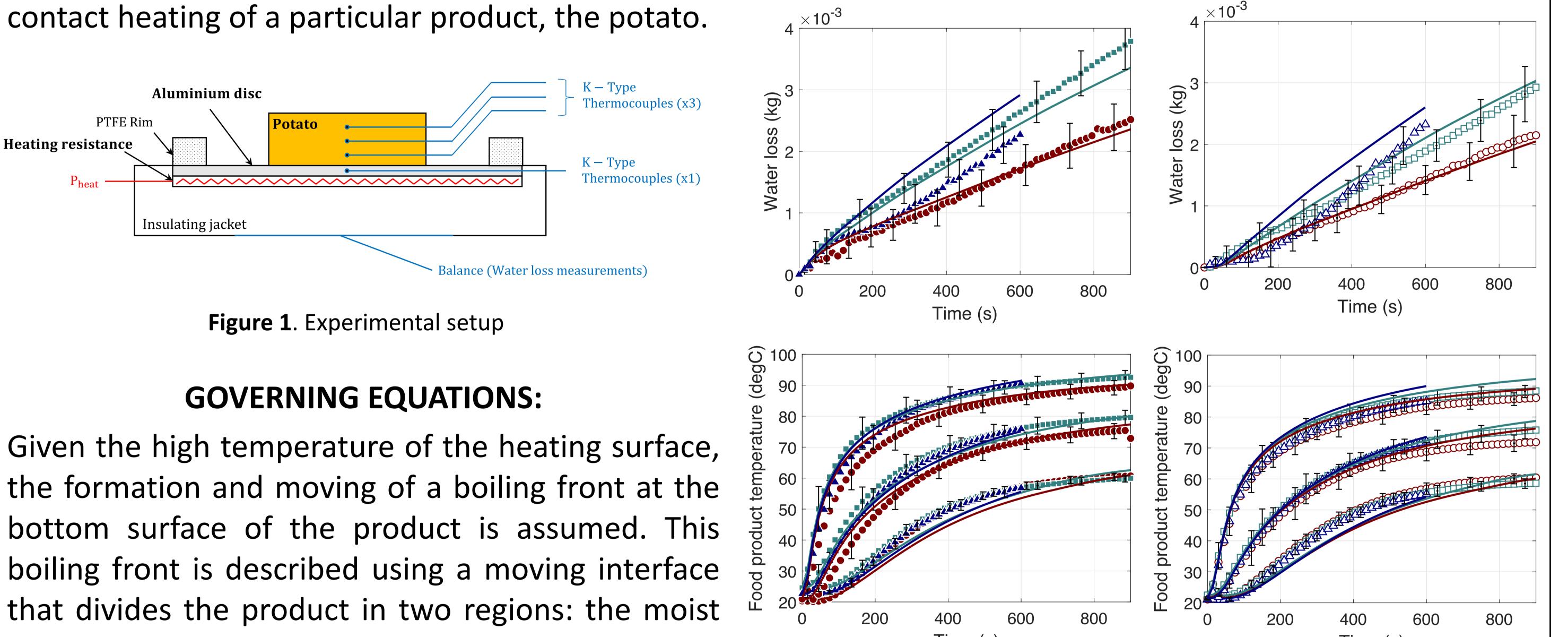
Studies concerning the contact heating of food products remain relatively rare in the literature despite the importance of this mode of heat transfer in many industrial and domestic operations such as grilling or pan-frying. In this work, a 2D mathematical model was developed and used to better understand heat and mass transfer during

#### **RESULTS**:

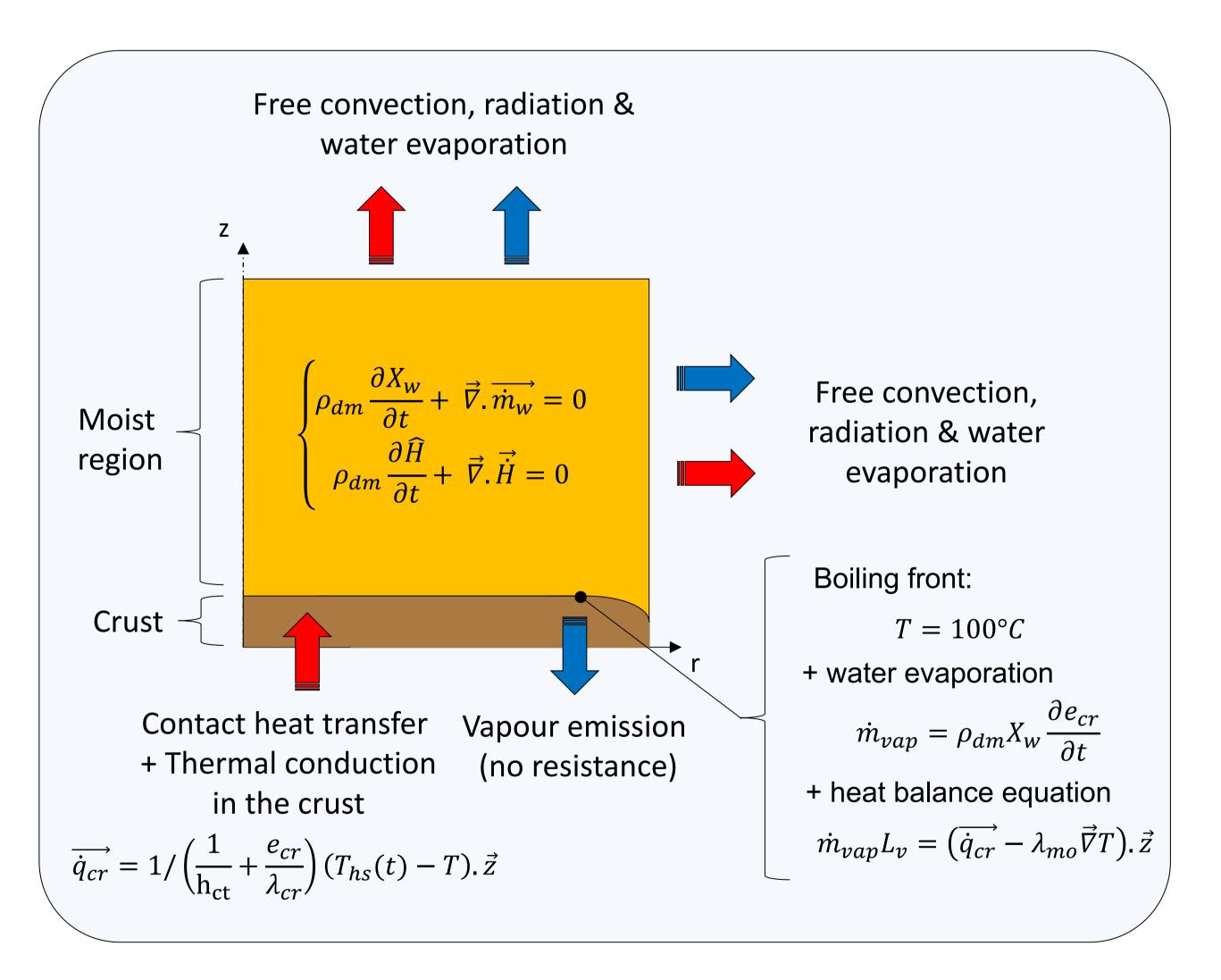
Simulated results are compared to experimental data obtained using the experimental device developed for this study. Results are shown for a constant heating power of 3.2 kW.m<sup>-2</sup> 6.4 kW.m<sup>-2</sup> and 9.6 kW.m<sup>-2</sup> with and without the presence of an oil layer below the product.

With oil

Without oil



## region and the dry region (the crust).

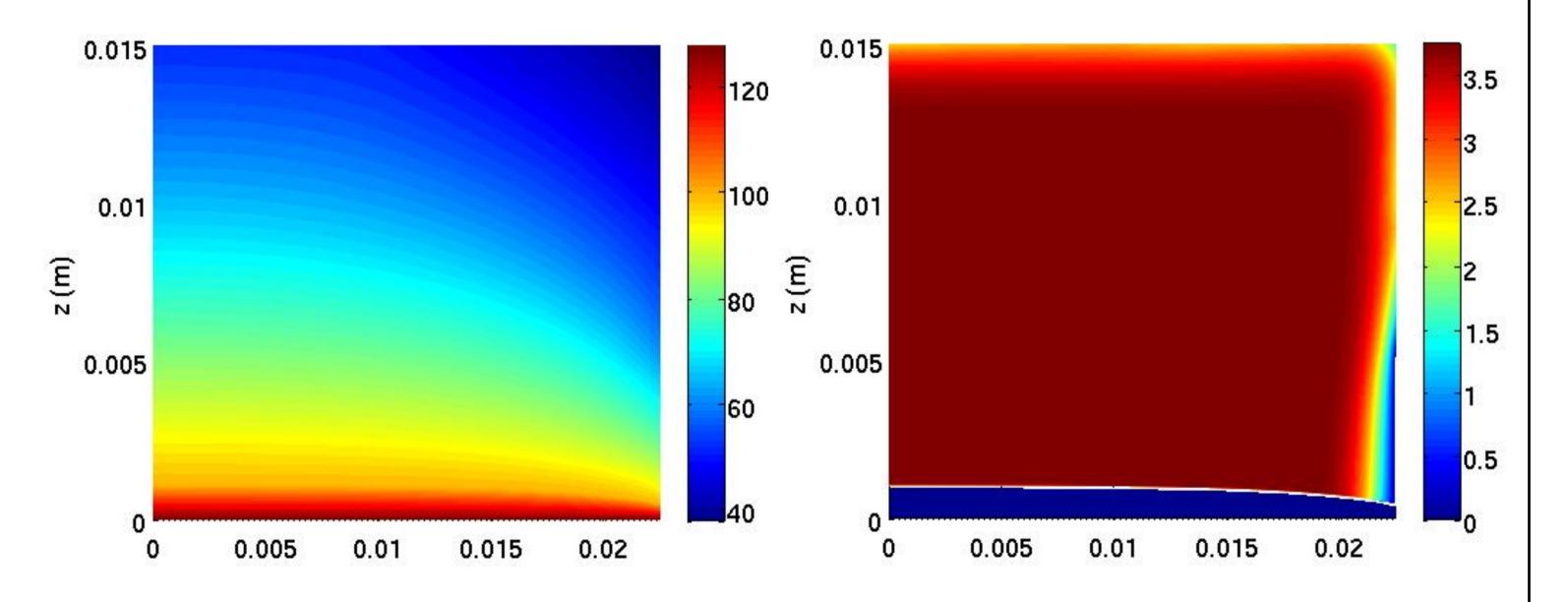


Time (s)

Time (s)

 $---3.2 \text{ kW.m}^{-2}$   $---6.4 \text{ kW.m}^{-2}$   $---9.6 \text{ kW.m}^{-2}$ 

**Figure 3**. Simulated and experimental results. Temperature profiles at three locations in the product and water loss kinetics.



**Figure 4**. Example of simulation results. Temperature and water content field obtained after 15 min of heating (3.2 kW.m<sup>-2</sup> with oil).

#### Figure 2. Governing equations

## **GEOMETRY & MODEL IMPLEMENTATION:**

- COMSOL Multiphysics 5.2
- 2D axisymmetric geometry
- Coefficient Form PDE for the moist region
- Boundary ODE for the boiling front and the crust
- Deformed geometry for the moving interface
- Free triangular mesh (4268 elements)

#### **CONCLUSIONS**:

The model was validated by showing good agreements between measured and calculated values of product temperature and water loss. Experimental characterization of the structure of the crust (porosity, permeability) is planned to improve model accuracy (especially for high heating power).

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